

1795

PATENT APPLICATION



IN THE U.S. PATENT AND TRADEMARK OFFICE

August 7, 2009

Applicant(s): Katsuyuki TSUCHIDA et al

For: COPPER ELECTROLYTIC SOLUTION CONTAINING AS ADDITIVE
COMPOUND HAVING SPECIFIC SKELETON, AND ELECTROLYTIC
COPPER FOIL MANUFACTURED THEREWITH

Serial No.: 10/588 686

Group: 1795

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(3) and 1.98, enclosed herewith is a copy of a Japanese language Office Action dated July 6, 2009, Form PTO-1449 and copies of the foreign references cited thereon.

Also enclosed is a copy of a Japanese language Office Action dated May 8, 2009, Form PTO-1449 and a copy of the reference cited thereon.

Further enclosed is a copy of a Japanese language Office Action dated April 9, 2009, Form PTO-1449 and copies of the references cited thereon. Japanese Patent Publication No. 10-330983 referenced in the Office Action dated April 9, 2009 was previously submitted and therefore is not included herein.

Further consideration is respectfully solicited.

Respectfully submitted,


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Encl: Copy of a Japanese language Office Action
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Form PTO-1449
One copy of each foreign cited reference
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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on August 7, 2009.


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